



Description

The EX-400 provides exceptionally low aging rates and tight temperature stabilities in an extremely small package over a wide range of environmental conditions. This EMXO series bridges the gap between current large, high precision OCXO's and smaller TCXO's. The EX-400 Series becomes the most economical choice where there is a need for spectral purity, short and long term stability, along with small size and dramatically reduced power consumption.

Features

- 4-Pin Dip
- · Uses Doubly Rotated Crystal
- Low Power Consumption: <0.35 watts @ +25°C
- Previous Model Number: EX-380, EX-381, EX-385 series
- Frequency Range: 10 MHz 80 MHz

Applications

- · SONET/SDH, DWDM, FDM, ATM, 3G
- Telecom Transmission and Switching Equipment
- Wireless Communication Equipment
- · Military Airborne and Mobile Systems

Performance Specifications

	Frequency Stabilities ¹						
Parar	neter	Min	Typical	Max	Units	Condition	
		-75 -100 -250		+75 +100 +250	ppb	-20 +70°C (10 to 20.49 MHz) -20 +70°C (10 to 50 MHz) -20 +70°C (10 to 80 MHz)	
vs. operating temperatu +25°C)	ure range (reference to	-100 -150 -250		+100 +150 +250	ppb	-40 +85°C (10 to 20.49 MHz) -40 +85°C (10 to 50 MHz) -40 +85°C (10 to 80 MHz)	
		-150 -250		+150 +250	ppb	-55 +85°C (10 to 50 MHz) -55 +85°C (10 to 80 MHz)	
vs. Stratum3 per GR-1244-	Operating Temp	-140 -140 -140		+140 +140 +140	ppb	-20 +70°C -40 +85°C (10 to 50 MHz) -55 +85°C (10 to 20.49 MHz)	
CORE	Holdover Drift MTIE	-370 -4.63		+370 +4.63 +1000	ppb 10-13/sec ns	24 hours Over 7100 seconds 0.16sec < Observe Times < 64 sec	
Warm-up Time				1 2	minutes	to \pm 1ppm of final frequency (1 hour) to \pm 100ppb of final frequency (1 hour)	
Initial Tolerance (10 to 19.9 MHz) Initial Tolerance (20 to 80 MHz)		-1.0 -1.5		+1.0 +1.5	ppm	for fixed frequency	
vs. supply voltage change (10 to 50 MHz) vs. supply voltage change (50 to 80 MHz)		-15 -25		+15 +25	ppb	VS ± 5%	
vs. load change (10 to 8	0 MHz)	-15		+15	ppb	Load ± 5%	

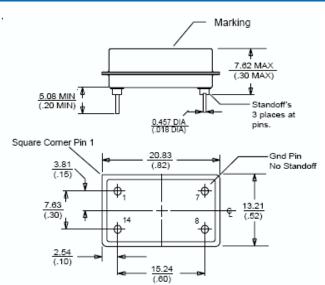
Performance Specifications

Frequency Stabilities ¹ (continued)					
Parameter	Min	Typical	Max	Units	Condition
vs. aging / day (10 to 14.9 MHz)	-1.0		+1.0		
vs. aging / day (15 to 19.9 MHz)	-2.0		+2.0	ppb	after 30 days of operation
vs. aging / day (20 to 49.9 MHz) vs. aging / day (50 to 80.0 MHz)	-3.0 -4.0		+3.0 +4.0		
vs. aging / 1st year (10 to 14.9 MHz) vs. aging / 1st year (15 to 19.9 MHz)	-200 -300		+200 +300	ppb	after 30 days of operation
vs. aging / 1st year (15 to 19.9 MHz)	-500		+500	l bbp	arter 30 days or operation
vs. aging / 10 year (10 to 14.9 MHz)	-1000		+1000		
vs. aging / 10 year (10 to 14.9 MHz)	-2000		+2000	ppb	after 30 days of operation
vs. aging / 10 year (20 to 80 MHz)	-3000		+3000		arter so days or operation
		Supply \	/oltage (V	(3	
Supply voltage (Vs)	4.75	5.0	5.25	VDC	
Supply voltage (Vs)	3.135	3.3	3.465	VDC	
Supply voltage (vs)	3.133	3.3		VDC	
			1.5		during warm-up
			0.35		steady state @ +25°C (10 to 29.99 MHz)
Power Consumption			0.45	Watts	steady state @ +25°C (30 to 80 MHz)
			0.7		steady state @ -40°C (10 to 29.99 MHz)
			0.8		steady state @ -40°C (30 to 80 MHz)
		RF (Output		steady state of 10 c (co to co
Signal [Standard]			MOS		
Signal [Standard]		_	VIO3	-	
Load		15		pF	
Signal Level (Vol)			0.4	VDC	
Signal Level (Voh)	4.0 2.6			VDC	Vs=5 Vdc Vs=3.3 vdc
Rise/Fall Time			+5	ns	(10-80%) of Vs
Duty cycle	40		60	%	(Voh-Vol)/2
gnal [Option] Sinewave					
Load					
Output Power [Standard]	0		+4	dBm	50 ohm load
Output Power [Option]	+3		+7	dBm	50 ohm load
Output Fower [Option]		F.,			Jo offitt load
		Frequency		FC)	
Tuning Range		Fixed OCX); No adjust		
	±1.0		±5.0		with 10 to 14.99 MHz
Tuning Range	±2.0 ±3.0		±8.0 ±10.0	ppm	with 15 to 20.48 MHz with 20.5 to 49.99 MHz
	±3.0 ±4.0		±10.0 ±12.0		with 50 to 80 MHz
Control Voltage Range	0		Vs	VDC	With 50 to co in iz
Tuning Slope		Doc	itive	1 ****	
Turning Slope		1			Desire a Wesser
Oven Alarm Logic	4.0		0.4	VDC	During Warmup Vs=5.0 Vdc After Warmup
Oven Alaini Logic	2.6			\ \bc	Vs=3.3 Vdc After Warmup
		Additiona	l Paramet	ers	
		-120			10 Hz
		-140			10112 100 Hz
Phase Noise @ 10 MHz (Typical)		-145		dBc/Hz	1 kHz
		-155			10 kHz
	-155 100 kHz				
	-100 10 Hz				
DI N. 1 - 25 1111 (7 1 1 1		-130		ID "	100 Hz
Phase Noise @ 20 MHz (Typical)				dBc/Hz	1 kHz 10 kHz
		-145 -150			10 kHz
		1 .55			100 1312

Frequency Stabilities ¹ (continued)					
Parameter	Min	Typical	Max	Units	Condition
Additional Parameters					
Phase Noise @ 50 MHz (Typical)		-80 -110 -130 -135 -140		dBc/Hz	10 Hz 100 Hz 1 kHz 10 kHz 100 kHz

		-140			TUU KHZ	
	Additional Parameters (continued)					
Parameter	Min	Typical	Max	Units	Condition	
Allan Deviation			0.2	ppb	Tau = 1 sec to 10 sec (10 to 20.49 MHz)	
Allari Deviation			0.5		Tau = 1 sec to 10 sec (20.5 to 80 MHz)	
Acceleration Sensitivity (10 MHz)			1.0	ppb/g	Total Gamma	
Weight			5	g		
	Al	bsolute Ma	ximum Ra	tings		
c lyb			5.5	VDC	with Vs=5 V	
Supply Voltage			5.5		with Vs=3.3 V	
Output Load			30	pF		
Operable temperature range	-55		+85	°C		
Storage temperature range	-55		+85	°C		
	5	tandard E	nvironmer	ntals		
Vibration - Sine	MIL-STD-2	02, Method 2	204, Conditio	on D (20 G, 1	0Hz-2000Hz)	
Vibration - Random	Vibration - Random MIL-STD-202, Method 214, Condition I-F (20 Grms, 10Hz-2000Hz)		ms, 10Hz-2000Hz)			
Shock	MIL-STD-2	MIL-STD-202, Method 213, Condition E (1000 G, 0.5ms, halfsine)				
Solderability	MIL-STD-2	MIL-STD-202, Method 208				

Outline Drawing / Enclosure

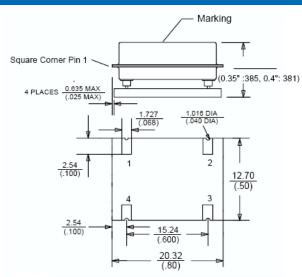


Dimensions in mm (inches)

	Type A	
Code	Height "H"	Pin Length "L"
0	7.62	5.08

	Pin Connections
1	EFC \ No Connect \ Oven Monitor
7	Ground (Case)
8	RF Output
14	Supply Voltage Input

Outline Drawing / Enclosure

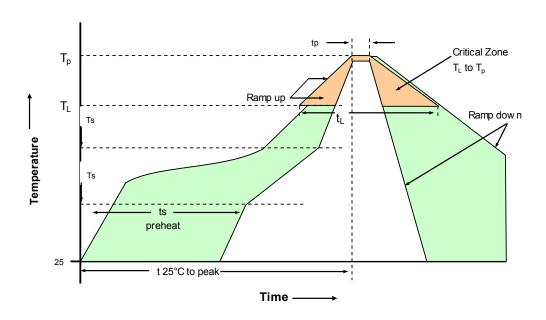


Dimensions in mm (inches)

	Type B	
Code	Height "H"	Pin Length "L"
1	8.9 (0.35")	NA
2	10.2 (0.4")	NA

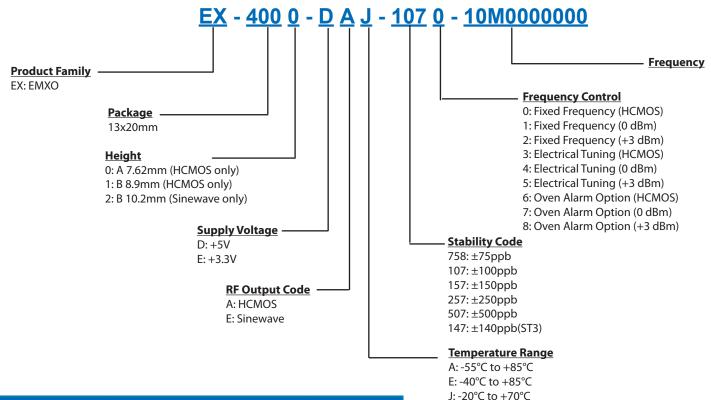
	Pin Connections
1	EFC \ No Connect \ Oven Monitor
7	Ground (Case)
8	RF Output
14	Supply Voltage Input

Recommended Reflow Profile



Profile Feature	Sn-Pb Assembly	Profile Feature	Sn-Pb Assembly
PRECAUTION: Series shall not expose to higher than 230°C, stabil		an 230°C. If exposing to temperature tion may permanently degrade.	
Average ramp-up rate (TL to Tp)	3°C/second max.	Time 25°C to Peak Temperature	4 minutes max.
Preheat -Temperature Min Tsmin) -Temperature Min Tsmax) -Time (min to max) (ts)	135°c 155°c 60-90 seconds	Time maintained above - Temperature (TL) - Time (tL)	183°C 45-60 seconds
Tsmax to TL - Ramp-up Rate	3°C/second max.		
Time maintained above - Temperature (TL) - Time (tL)	183°C 45-60 seconds	Time within 5°C of actual Peak Temperature (tp)	10-20 seconds max.
Peak Temperature (Tp)	max 220°C	Ramp-down Rate	6°C/second max.
Note: All temperatures refer to topside of the package, measured on the package body surface.			

Ordering Information



Temperature Range and Stability Table					
Stability/Temperature	A: -55°C to +85°C	E: -40°C to +85°C	J: -20°C to +70°C		
758: (±75ppb)			10 to 20 MHz		
107: (±100ppb)	10 to 40 MHz	10 to 40 MHz	10 to 65 MHz		
157: (±150ppb)	10 to 65 MHz	10 to 65 MHz	10 to 65 MHz		
257: (±250ppb)	10 to 80 MHz	10 to 80 MHz	10 to 80 MHz		
507: (±500ppb)	10 to 80 MHz	10 to 80 MHz	10 to 80 MHz		
147: (±140ppb(ST3))	10 to 65 MHz	10 to 65 MHz	10 to 65 MHz		

Frequency Range
10 to 20 MHz
10 to 40 MHz
10 to 65 MHz
10 to 80 MHz

Notes:

- Contact factory for improved stabilities or additional product options. Not all options and codes are available at all frequencies.
- Unless other stated all values are valid after warm-up time and refer to typical conditions for supply voltage, frequency control voltage, load, temperature (25°C).
- 3. Phase noise degrades with increasing output frequency.
- 4. Subject to technical modification.
- 5. Contact factory for availability.

Contact Information

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